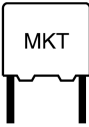


MKTFILM Capacitor

Material Data Sheet

Product Class	MKT Boxed B32520x/521x/522x Capacitor	
Date	18/11/2019	
IMDS ID if available	NA	
Version	5.02.1a (03/2019)	

Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS** [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	Polymer	2A	Polyethylene terephthalate (PET)	100	25038-59-9	13,5	
	Heavy metal	1C	Tin	97	7440-31-5	15	
	Heavy metal	1C	Copper	3	7440-50-8		
	Light Metals	1B	Aluminium	100	7429-90-5	5	
Encapsulation	Polymer	2A	Poly(1,4-butylene terephthalate) (PBT)	60	26062-94-2	24,8	
	Mineral Materials	3A	Fiber Glass	21,5	65997-17-3		
	Functional Material	4B	Tetrabromobisphenol A Carbonate Oligomer (TBBPA)	18,5	71342-77-3		
	Functional Material	4B	Tetrabromobisphenol A Diglycidye Ether		68928-70-1		
	Inorganic Solid	4A	Diantimony Trioxide		1309-64-4		
	Duromer	2C	Bisphenol A Epoxy Resin	90	25068-38-6	29,9	
	Acid, Salt, Base	6F	others *)	10	-		
Termination	Heavy metal / Metallic	1C / 1A	Copper or Iron/Copper	100	7440-50-8 / 7439-89-6	10,6 or 8,3 / 2,3	
				100			
	Heavy metal	1C	Tin	100	7440-31-5		1,2
Sum in total:						100	

sizes [lxwxh]	weight range [g]	part numbers	sizes [lxwxh]	weight range [g]	part numbers	sizes [lxwxh]	weight range [g]	part numbers
2,5x7,0x10,0mm	0,30	B32520*	4,0x7,0x13,0mm	0,52	B32521*	5,0x10,5x18,0mm	1,50	B32522*
3,0x8,0x10,0mm	0,40		4,0x9,0x13,0mm	0,70		6,0x11,0x18,0mm	1,90	
4,0x8,5x10,0mm	0,52		5,0x11,0x13,0mm	1,10		6,0x12,0x18,0mm	2,10	
5,0x10,5x10,0mm	0,80		6,0x12,0x13,0mm	1,40		7,0x12,5x18,0mm	2,50	
6,0x12,0x10,3mm	0,98					8,0x14,0x18,0mm	3,20	
						8,5x14,5x18,0mm	3,30	
						9,0x17,5x18,0mm	4,50	
						11,0x18,5x18,0mm	5,60	

Not Part of a Product Class

Contact	Perosa, Eduardo	Important remarks: 1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated. 2) This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.
Division	CAP FILM, (GTI EPQM)	
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*) others: .(not declarable or prohibited substances acc. GADSL) **) typical mass percentage of substance		

The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

RoHS - Exemptions for the Product Class / Product according to Annex III: (valid not valid)

- no exemptions;**
- Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;
- Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;
- Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;
- Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);
- Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;
- Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;
- Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;
- Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;
- Other Exemption than above